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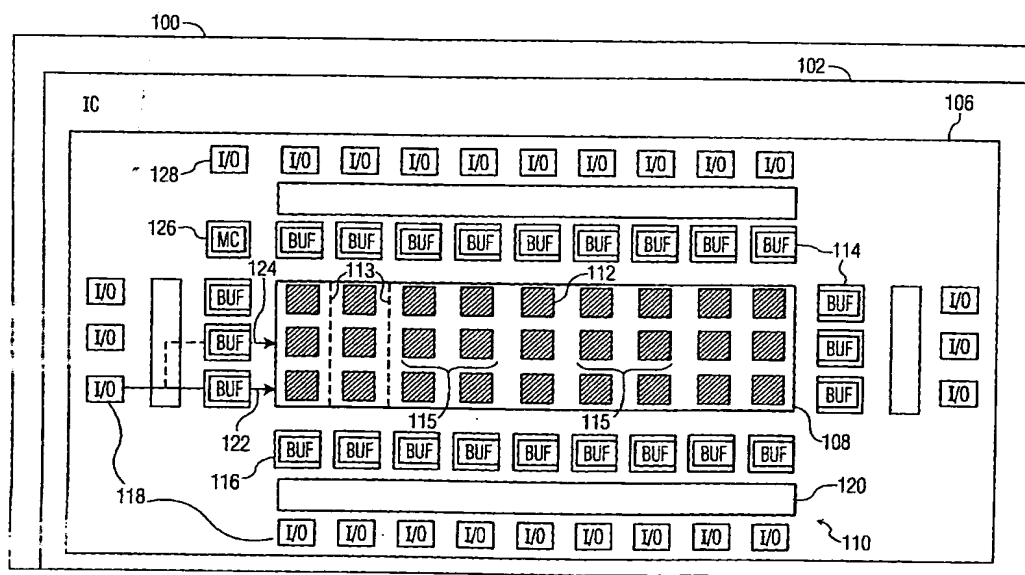
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(54) Title: MODULAR INTEGRATION OF AN ARRAY PROCESSOR WITHIN A SYSTEM ON CHIP



(57) Abstract: A systolic array processor is integrated within a system on chip (SoC) in a format that is compatible with existing and emerging SoC technologies. The systolic array processor may be implemented as a co-processor to a general-purpose digital signal processor or as a functional unit of a very long instruction word (VLIW) processor.

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